

SOM-Q7-MX6

Qseven® standard module with NXP i.MX 6 Processor

Optimal balance of performance and power



HIGHLIGHTS





CONNECTIVITY
2x serial ports; CAN port

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GRAPHICS

(1) Available in Industrial Temperature Range

2D/3D dedicated graphics processors



MEMORY

up to 4GB DDR3L on-board











MAIN FIELDS OF APPLICATION











Transportation

Safety & Surveillance

Industrial Automation

•← USB

Digital Signage

Utilities

1 x USB OTG interface

FEATURES

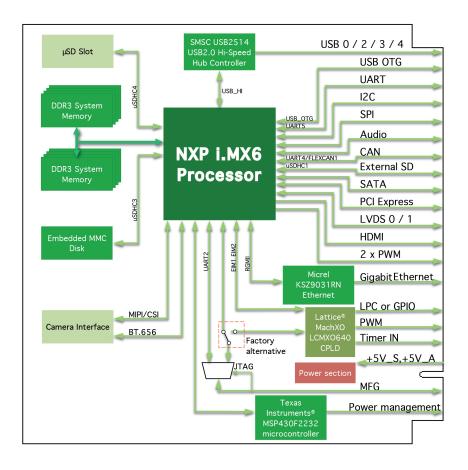
FEATORES			
	Processor	NXP i.MX 6 Family, based on Arm® CORTEX-A9 processors i.MX6S Solo - Single core up to 1GHz i.MX6DL Dual Lite - Dual core up to 1GHz per core i.MX6D Dual - Dual core up to 1GHz per core i.MX6DP DualPlus - Dual core up to 1GHz per core i.MX6DP Quad - Quad core up to 1GHz per core	
8	Max Cores	4	
A	Memory	Up to 4GB DDR3L on-board (up to 2GB with i.MX6S)	
Ş	Graphics	Dedicated 2D Hardware accelerator Dedicated 3D Hardware accelerator, supports OpenGL® ES 2.0 3D Dedicated Vector Graphics accelerator supports OpenVGTM (only i.MX6D, i.MX6DP and i.MX6Q) Enhanced 2D and 3D graphics with i.MX6DP Supports up to 3 independent displays with i.MX6D, i.MX6DP and i.MX6Q Supports 2 independent displays with i.MX6DL and i.MX6S	
1	Video Interfaces	1 x LVDS Dual Channel or 2 x LVDS Single Channel 18 / 24 bit interface HDMI® Interface 1.4 Video Input Port / Camera Connector	
	Video Resolution	LVDS, up to 1920x1200 HDMI®, up to 1080p	
9	Mass Storage	On-board eMMC drive, up to 32 GB SD / MMC / SDIO interface 1 x µSD Card Slot on-board 1 x External SATA Channel (only available with i.MX6D and i.MX6Q)	
용	Networking	Gigabit Ethernet interface	

		4 x USB 2.0 Host interfaces
:::::	PCI-e	1 x PCI-e x1 lane (only PCI-e 1.1 and Gen2 are supported)
11.11	Audio	AC'97 Audio interface I2S
ē _ ō	Serial Ports	2 x Serial ports (TTL interface) CAN port interface
	Other Interfaces	I2C Bus LPC Bus SM Bus Power Management Signals
	Power Supply	+5V _{DC} ± 5%
OS	Operating System	Linux Yocto Microsoft® Windows Embedded Compact 7
	Operating Temperature*	0°C ÷ +60°C (Commercial version) -40°C ÷ +85°C (Industrial version)
	Dimensions	70 x 70 mm (2.76" x 2.76")

*Measured at any point of SECO standard heatspreader for this product, during any and all times (including start-up). Actual temperature will widely depend on application, enclosure and/or environment. Upon customer to consider application-specific cooling solutions for the final system to keep the heatspreader temperature in the range indicated.



BLOCK DIAGRAM





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EDGEHOG OS

A flexible operating system that adapts to your needs, thanks to the customization tool and Docker support. Reliability and security are built-in through a dual-partition system and native integration with Exein's robust Al-based protection.

DATA ORCHESTRATION

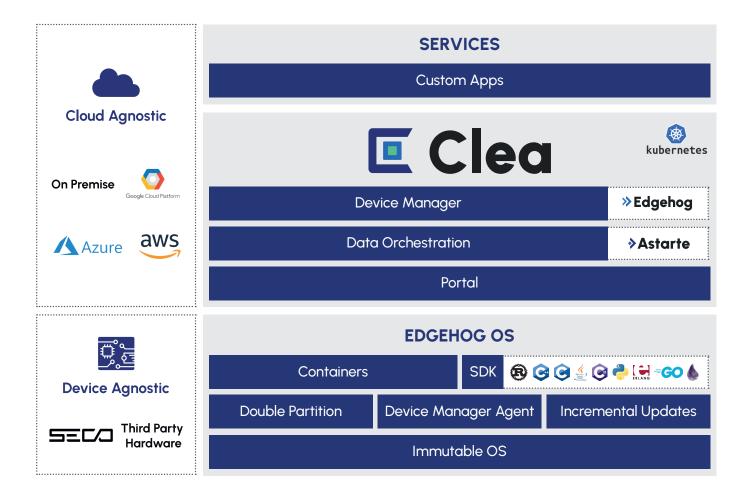
Integrate third-party services, simplify data flows and analysis, and enhance business efficiency by enabling easy and fast utilization of AI.

DEVICE MANAGER

Update, configure, and manage remote devices. Optimize time and costs to maximize operational efficiency and security without the need for costly field interventions.

PORTAL

Analyze data from remote devices, customize the user experience with applications tailored to user needs, and manage user rights, company access, and tenant privileges.



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EDGEHOG OS



CLEA DOCS



